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	et No. 7272-128/10308949			
	· · · · · · · · · · · · · · · · · · ·	2. Name and address of receiving party:		
1.	Name of conveying party(ies): Hideo SEKI, Sukeyuki SHINOTSUKA, Makoto	Name: HONDA GIKEN KOGYO KABUSHIKI KAISHA		
	FURUKAWA, Koji ODA, Keiji OTSUKA, Jiro KIRITA,	Name. HONDA GIREN ROGTO RABUSHIRI RAISHA		
	Nobuhiro FUEKI and Hironori WATANABE	Internal Address		
		Internal Address:		
	☐ Yes ☒ No ☐ ☐ ☐ Yes ☒ No ☐ ☐ Yes ☒ No ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐	0.4 7.		
3.	Nature of conveyance:	City: State: Zip:		
	✓ Assignment			
	☐ Security Agreement ☐ Change of Name	Street Address: 1-1, Minami Aoyama, 2-chome,		
	The state of the s			
	Other	City: Minato-ku State: Tokyo, Japan Zip: 107		
	Nature of conveyance: ☐ Assignment ☐ Security Agreement ☐ Other ☐ Other			
	Execution Date: December 5, 2003, respectively	Additional name(s) & address(es) attached?		
1.	Application number(s) or patent number(s):			
If this document is being filed together with a new application, the execution date of the application is:				
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١.	Patent Application No(s).:	B. Patent No(s).:		
. ^	644 E07 Elad August 40, 0000			
10/	641,587, filed August 12, 2003			
Additional numbers attached 2 🗀 Vac. M Ale				
Additional numbers attached? Yes No				
5.	Name and address of party to whom correspondence	6. Total number of applications and patents involved: 1		
	concerning document should be mailed:			
	Name: Conrad R. Solum, Jr.	7. Total fee (37 CFR 3.41): \$40.00		
		☐ Enclosed		
	Internal Address: Fulbright & Jaworski LLP			
	865 So. Figueroa St., 29 th Floor	☐ Charge this Deposit Account if any additional fee		
	Los Angeles, CA 90017-2576	required		
		8. Deposit Account Number: 50-0337		
DO NOT USE THIS SPACE				
9.	Statement and signature:	Statement and signature:		
	To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the			
	original document.			
	Com Made la	Date: 1/27/04		
	urad R. Solum, Jr., Reg No. 20,467	Date:		
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incidency time for reviewing the document and gathering the data needed, and completing and reviewing the sample cover sheet				
Send comments regarding this burden estimate to the U.S. Patent and Trademark Office, Office of Information Systems, PK2-				
	1000C, Washington, D.C. 20231, and to the Office of Managen	nent and Budget, Paperwork Reduction Project, (0651-0011),		
	Washington, D.C. 20503			
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PATENT REEL: 014952 FRAME: 0706

ASSIGNMENT OF PATENT APPLICATION

WHEREAS, WE, Hideo Seki, Sukeyuki Shinotsuka, Makoto Furukawa, Koji Oda, Keiji Otsuka, Jiro Kirita, Nobuhiro Fueki and Hironori Watanabe, citizens of Japan (hereinafter referred to as "ASSIGNORS"), have invented a certain invention entitled WELDING CONDITION MONITORING DEVICE for which application for Letters Patent of the United States of America has been filed August 12, 2003, assigned Serial No. 10/641,587; and

WHEREAS, HONDA GIKEN KOGYO KABUSHIKI KAISHA, a corporation organized and existing under and by virtue of the laws of Japan and having its place of business at 1-1, Minamiaoyama, 2-chome, Minato-ku, Tokyo 107-8556, Japan (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring the exclusive right, title and interest in, to and under said invention and in, to and under any Patent or similar legal protection to be obtained therefor in the United States of America, its territorial possessions and in any and all countries foreign thereto.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns, the full and exclusive right, title and interest to said invention and to all Letters Patent or application or similar legal protection, not only in the United States and its territorial possessions, but in all countries foreign thereto to be obtained for said invention by said application, and to any continuation, division, renewal, substitute or reissue thereof or any legal equivalent thereof in the United States or a foreign country for the full term or terms for which the same may be granted, including all priority rights under the International Convention; and ASSIGNOR hereby authorize and request the United States Commissioner of Patents and Trademarks and any officials of foreign countries whose duty it is to issue patents or any legal equivalent thereof to said ASSIGNEE, its successors and assigns, in accordance with this Assignment.

ASSIGNOR hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Agreement; 25360463.1

PATENT REEL: 014952 FRAME: 0707 ASSIGNOR further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents in the United States or in any foreign country, which may be necessary or desirable to carry out the purposes thereof.

WITNESS OUR HAND:

Dated: December 5, 2003	Hilu Idu Hideo Seki
Dated: December 5, 2003	Sukeyuki Shinofsuka
Dated: December 5, 2003	Makoto Furukawa Makoto Furukawa
Dated: December 5, 2003	Koji Oda Koji Oda
Dated: December 5, 2003	Keiji Otsuka
Dated: December 5, 2003	Jiro Kurita
Dated: December 5, 2003	Nobuhiro Fuelki
Dated: December 5, 2003	Hironari Watanabe Hironori Watanabe

25360463.1

RECORDED: 01/30/2004

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PATENT REEL: 014952 FRAME: 0708